

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Erwin Ian V. Almagro</td> <td>10/05/2007</td> </tr> <tr> <td>Honorio T. Granada Jr.</td> <td>10/05/2007</td> </tr> <tr> <td>Paul Armand Calo</td> <td>10/05/2007</td> </tr> </tbody> </table>		Name	Execution Date	Erwin Ian V. Almagro	10/05/2007	Honorio T. Granada Jr.	10/05/2007	Paul Armand Calo	10/05/2007		
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Fairchild Semiconductor Corporation</td> </tr> <tr> <td>Street Address:</td> <td>82 Running Hill Road</td> </tr> <tr> <td>City:</td> <td>South Portland</td> </tr> <tr> <td>State/Country:</td> <td>MAINE</td> </tr> <tr> <td>Postal Code:</td> <td>04106</td> </tr> </table>		Name:	Fairchild Semiconductor Corporation	Street Address:	82 Running Hill Road	City:	South Portland	State/Country:	MAINE	Postal Code:	04106
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CORRESPONDENCE DATA											
<p>Fax Number: (585)295-4401</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: (585) 295-4469</p> <p>Email: tfitzgerald@hblaw.com</p> <p>Correspondent Name: Thomas R. FitzGerald, Esq.</p> <p>Address Line 1: Hiscock & Barclay, LLP</p> <p>Address Line 2: 2000 HSBC Plaza, 100 Chestnut St.</p> <p>Address Line 4: Rochester, NEW YORK 14604-2404</p>											
ATTORNEY DOCKET NUMBER:	3025653										
NAME OF SUBMITTER:	Thomas R. FitzGerald										
<p>Total Attachments: 2</p> <p>source=Assignment#page1.tif</p>											

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PATENT
REEL: 022605 FRAME: 0992

FAIRCHILD SEMICONDUCTOR CORPORATION

Assignment

As a below named inventor or joint inventor of an invention or improvement entitled:

**METHOD FOR CONNECTING A DIE ATTACH PAD
TO A LEAD FRAME AND PRODUCT THEREOF
(Attorney Docket No. 3025653 (17732.68950.00))**

filed on an even date herewith; and

WHEREAS, FAIRCHILD SEMICONDUCTOR CORPORATION, a Corporation, organized and existing under the laws of the State of Delaware, having its principal office and place of business in the City of South Portland, State of Maine, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I have sold, assigned, transferred, and set over, and by these presents do hereby sell, assign, transfer and set over, unto said FAIRCHILD SEMICONDUCTOR CORPORATION, its successors, legal representatives, and assigns, my entire right, title and interest in, to, and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuation applications thereof, and all Letters Patent of the United States of America which may be granted thereof and all reissues and extensions hereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention, all rights to register said invention in appropriate registries, and all Letters Patent which may be granted for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to said FAIRCHILD SEMICONDUCTOR CORPORATION, its successors, legal representatives, and assigns, in accordance with the terms of this instrument.

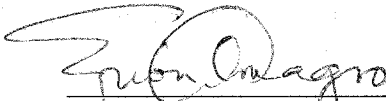
And I hereby covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

Docket:
17732.68950.07

And I hereby further covenant and agree that I will communicate to said FAIRCHILD SEMICONDUCTOR CORPORATION, its successors, legal representatives, and assigns, any fact known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisions, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid said FAIRCHILD SEMICONDUCTOR CORPORATION, its successors, legal representatives, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN TESTIMONY WHEREOF, I authorize and affirm said assignments with the signature(s) set forth below on the indicated date(s).


Inventors:



Erwin Ian V. Almagro

Oct. 5, 2007

Date



Honorio T. Granada, Jr.

Oct. 5, 2007

Date



Paul Armand Calo

Oct. 5, 2007

Date